

SFP+ 9953M(Tx)9953M&2488M(Rx) XGS-PON OLT E1 20 km (OM5270SX600)





## **Product Features**

- Single-fiber bi-directional transmission
- SFP+ package
- 2 x 11 SFP+ electrical interface, support 20 PIN or 22 PIN System
- Hot-pluggable
- Typical power consumption 1.8 W
- SC receptacle optical connector
- Operating case temperature: 0°C to 70°C
- 3.3 V power supply
- ODN Class E1
- RoHS 2 compliant
- ITU-T G. 987.2 compliant
- ITU-T G. 9807.1 compliant

## **Applications**

- Gigabits Access Networks
- **FTTH**
- **FTTC**
- **FTTB**
- XGS-PON Access Networks



## 1. Function Description

OM5270SX600 is an XGS-PON OLT in an SFP+ housing that meet ITU-T G. 9807.1 standard. XGS-PON feature supports 9.953 Gbps continuous-mode transmission by 1577 nm EML laser and 9.953 Gbps/2.488 Gbps burst-mode reception by 1270 nm APD/TIA.

It has been designed to meet the harshest external operating conditions that include temperature, humidity and EMI interference. The module offers very high functionality and feature integration, accessible via a two-wire serial interface. A block diagram is shown in Figure 1-1.

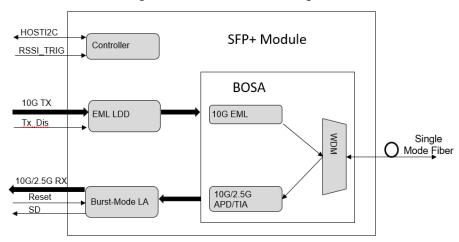


Figure 1-1 Transceiver Block Diagram

## 2. Pin Description

22 **GND** NC 2 21 Rate Sel XGS PON TD-3 20 TX Fault XGS PON TD+ 4 19 GND TX Disable 5 18 SDA VCC 6 17 VCC 7 16 GND MOD\_ABS(GND) 15 **XGS PON Reset** XGS PON RD+ 9 14 XGS PON SD XGS PON RD-10 RSSI Trig 13 GND 11 GND 12 NC Bottom of Board Top of Board As viewed trough top of board

Figure 2-1 MSA compliant connector

# 3. Mechanical Specifications

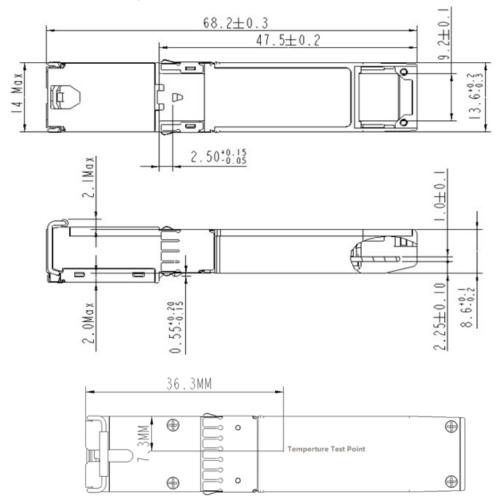


Figure 3-1 OM5270SX600 mechanical dimensions

# 4. Ordering Information

Part Number	Description
OM5270SX600	SFP+, 9.953G (Down)/9.953G/2.488 (Up), XGS-PON OLT E1, 20 km

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